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# FDB075N15A-F085

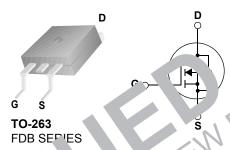
N-Channel Power Trench® MOSFET **150V**, **110A**, **7.5m**Ω

#### **Features**

- Typ  $r_{DS(on)}$  = 5.5m $\Omega$  at  $V_{GS}$  = 10V,  $I_D$  = 80A
- Typ  $Q_{q(tot)}$  = 80nC at  $V_{GS}$  = 10V,  $I_D$  = 80A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

#### **Applications**

- Automotive Engine Control
- Powertrain Management
- Solenoid and Motor Drivers
- Integrated Starter/alternator
- Primary Switch for 12V Systems





#### MOSFET Maximum Rating unless sinerwise notes

Symbol	rameter	Ratings	Units
$V_{DSS}$	Drain to Sc ce Voltage	150	V
$V_{GS}$	Gate to Sc ce Volta :	±20	V
ı	r un currei Cont uous (V <sub>GS</sub> =10) (Note 1) T <sub>C</sub> =25°C	110	Α
ID	n Current 7 <sub>C</sub> = 25°C	See Figure4	A
Eng	Single Pr : Avalanche Energy (Note 2)	502	mJ
1p	'owe, Dissipation	333	W
$P_{D}$	L _rate abo 'e 2 <sup>5</sup> °C	2.22	W/°C
$T_{J}, T_{G}$	Operating and Stolage Temperature	-55 to + 175	°C
· JC	Thermal Resistance Junction to Case	0.45	°C/W
$R_{\theta J \Lambda}$	Maximum 1 hermal Resistance Junction to Ambient (Note 3)	43	°C/W

## Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB075N15A	FDB075N15A-F085	D2-PAK(TO-263)	330mm	24mm	800 units

- 1: Current is limited by bondwire configuration.
  2: Starting  $T_J = 25^{\circ}C$ , L = 0.24mH,  $I_{AS} = 64$ A,  $V_{DD} = 100$ V during inductor charging and  $V_{DD} = 0$ V during time in avalanche
  3:  $R_{\theta,JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta JA}$  is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

Units

Max

Тур

# **Electrical Characteristics** T<sub>J</sub> = 25°C unless otherwise noted

**Parameter** 

Off Characteristics							
B <sub>VDSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, \	/ <sub>GS</sub> = 0V	150	-	-	V
I <sub>DSS</sub>	Drain to Source Leakage Current	V <sub>DS</sub> =150V,	$T_J = 25^{\circ}C$	-	-	1	μА
		$V_{GS} = 0V$	$T_J = 175^{\circ}C(Note 4)$	-	-	1	mA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA

**Test Conditions** 

Min

#### **On Characteristics**

Symbol

V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D}$	= 250μA	2.0	3 0		V
_	Drain to Source On Resistance	I <sub>D</sub> = 80A,	$T_{J} = 25^{\circ}C$	-	5.	7.₺	mΩ
rDS(on)	Dialii to Source On Resistance	V <sub>GS</sub> = 10V	$T_J = 175^{\circ}C(Note 4)$		14.2	20	mΩ

### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	J595 -	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 75V, V <sub>GS</sub> = 0V, f = 1MHz	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	- 16 -	pF
$R_g$	Gate Resistance	f = 1MH - 2.4 -	Q
$Q_{g(ToT)}$	Total Gate Charge at 10V	$V_C = 10 10$ $D = 75$ - 80 95	110
Q <sub>g(th)</sub>	Threshold Gate Charge	$V_{GS} = 2V$ $I_D = 85A$ - 1	nC
$Q_{gs}$	Gate to Source Gate Charge	- 26.5	nC
$Q_{gd}$	Gate to Drain "Miller" Charge	N 12 - 370 -	nC

# Switching Character stics

$t_{on}$	Turn-On ne	-	-	100	ns
$t_{d(on)}$	T n L ay Tim	-	33	-	ns
t <sub>r</sub>	$V_{DD} = 75V, V_{D} = 80A,$	-	46	-	ns
$t_{d(off)}$	Point-Off Play Time $V_{GS} = 10V + c_{EN} = 6\Omega$	-	76	-	ns
	Fa	-	25	-	ns
t <sub>off</sub>	urn-Off Time	-	-	138	ns

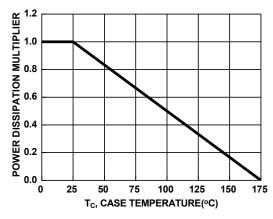
# Prair Source Diode Characteristics

1						
V	Source to Lirain Diode Vultage	$I_{SD} = 80A, V_{GS} = 0V$	1	-	1.25	٧
VSC	Source to Evalli block Strage	$I_{SD}$ = 40A, $V_{GS}$ = 0V	1	-	1.2	٧
L <sup>at</sup>	Reverse Recovery Time	$I_F = 80A$ , $dI_{SD}/dt = 100A/\mu s$ ,	1	118	132	ns
Q <sub>rr</sub>	Reverse Recovery Charge	V <sub>DD</sub> =120V	-	341	494	nC

#### Notes:

<sup>4:</sup> The maximum value is specified by design at  $T_J$  = 175°C. Product is not tested to this condition in production.

## **Typical Characteristics**



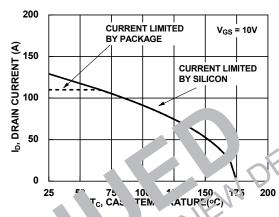


Figure 1. Normalized Power Dissipation vs Case Temperature

Figure 2. I. xin m C Itinuous brain Current vs Cass Temporature

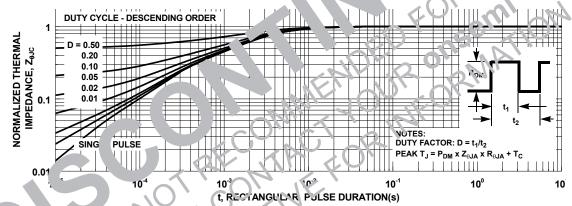


Figure 3. Normalized Maximum Transient Thermal Impedance

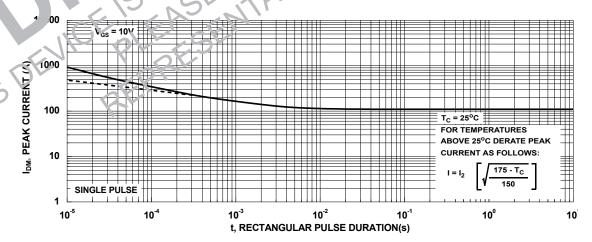


Figure 4. Peak Current Capability

# **Typical Characteristics**

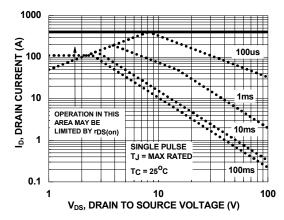
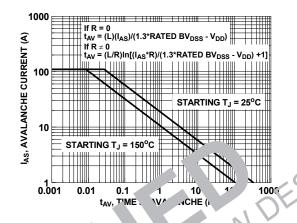
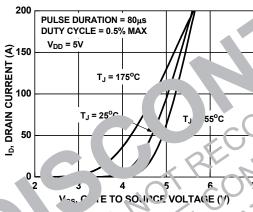


Figure 5. Forward Bias Safe Operating Area





F. re 7. Transfer Characteristics

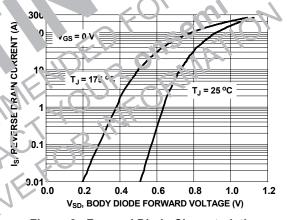


Figure 8. Forward Diode Characteristics

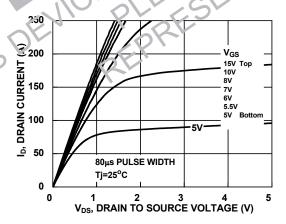


Figure 9. Saturation Characteristics

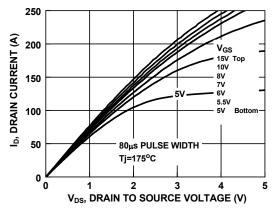


Figure 10. Saturation Characteristics

# **Typical Characteristics**

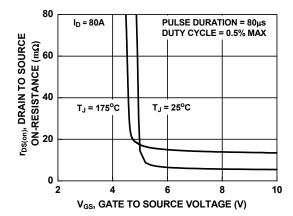


Figure 11. Rdson vs Gate Voltage

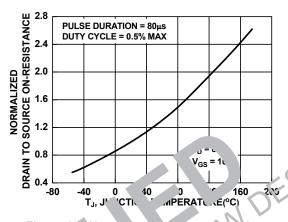
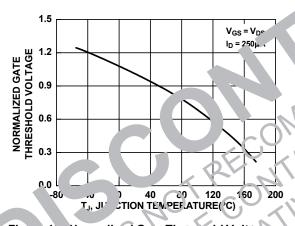


Figure 12 Norm zea Jon vs Junction
Ten erature



Figu 15 Vormalized Gate Threshold Voltage vs

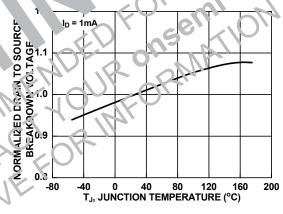


Figure 14. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

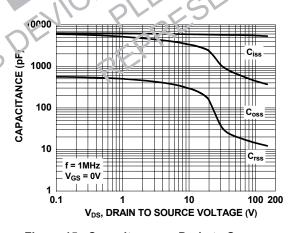


Figure 15. Capacitance vs Drain to Source Voltage

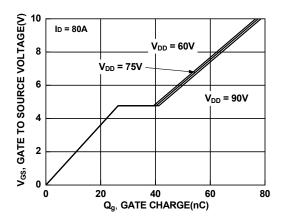


Figure 16. Gate Charge vs Gate to Source Voltage



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